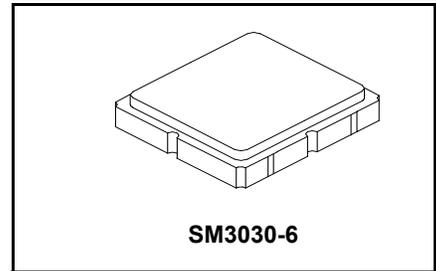


SAFCC314MSM0T33R12

**300 MHz
SAW Filter**



1. SCOPE

This Product specification is applied to SAFCC314MSM0T33R12, the 300MHz range SAW Filter used for communication equipment. Please contact us when using this product for any other applications than described in the above.

- COUNTRY OF ORIGIN: TAIWAN
- AEC-Q200 QUALIFIED

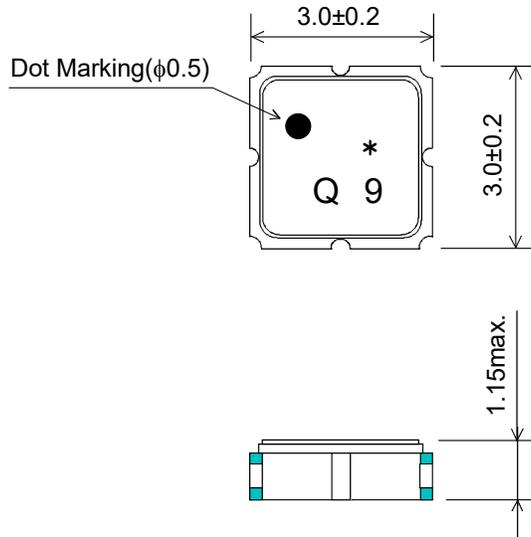
2. CUSTOMER NUMBER IF APPLICABLE

CUSTOMER PN	2AL-0008TA	Customer's Drawing No.	
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3. RFMi PART NUMBER:

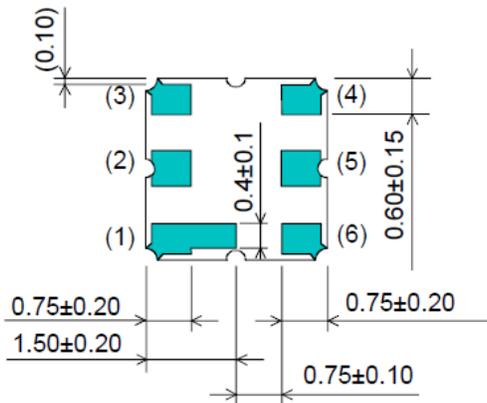
SAFCC314MSM0T33R12	TAPE/PACKING (2000pcs)
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4. DIMENSIONS



Marking: Laser Printing

* EIAJ Code



thickness 0.3...1.0 μ m
(Typ. 0.6 μ m)

Terminal(Base) : Ni

thickness 2.0...8.0 μ m
(Typ. 3.5 μ m)

Terminal Assignments

(2) : Input

(5) : Output

Others : Ground

Weight : 32±5mg

Coplanarity : 0.1mm max.

5. MAXIMUM RATINGS

5.1	Withstanding Voltage for short Term between each Terminal	Maximum Rating 10V D.C. (Insulation Resistance 10M Ω min. , 25 \pm 2 $^{\circ}$ C)
5.2	D. C. Voltage between each Terminal	Maximum Rating 3V D.C. Maximum allowable capacity 3V (25 \pm 2 $^{\circ}$ C)
5.3	Input Signal Level Allowable input level	1) 30mW (+14.8dBm), 1 minute 2) 20mW (+13dBm), 1000 hours
5.4	Operating Temperature Range	-40 $^{\circ}$ C to +105 $^{\circ}$ C
5.5	Storage Temperature Range	-40 $^{\circ}$ C to +85 $^{\circ}$ C

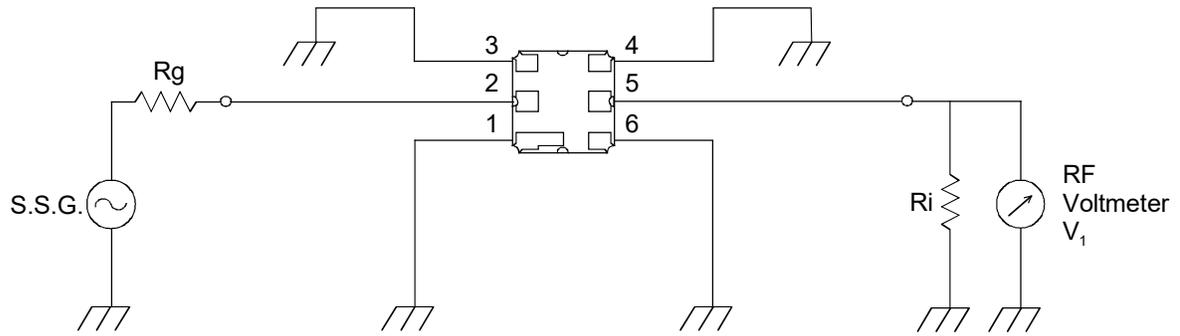
6. ELECTRICAL CHARACTERISTICS

	Item	Specifications
6.1	Nominal Center Frequency (fc)	314.85 MHz
6.2	Insertion Loss 1) 314.65 ~ 315.05 MHz (Pass Bandwidth) 2) 10.00~293.90 MHz 3) 293.90~295.00 MHz 4) 295.00~305.00 MHz 5) 325.00~335.00 MHz 6) 335.00~336.05 MHz 7) 336.05~336.45 MHz 8) 336.45~351.00 MHz 9) 351.00~1000.00 MHz	3.0 dB max. 50 dB min. 45 dB min. 25 dB min. 22 dB min. 40 dB min. 50 dB min. 45 dB min. 50 dB min.
6.3	Ripple Deviation (314.65 ~ 315.05MHz)	1.5 dB max.
6.4	VSWR (314.65 ~ 315.05MHz)	2.0 max.
6.5	Input/Output Impedance (nominal)	50 Ω

※ Unless otherwise specified, all tests shall be carried out on the standard atmospheric conditions [Temperature : 5~35 $^{\circ}$ C, Humidity : 45~85% R.H.]

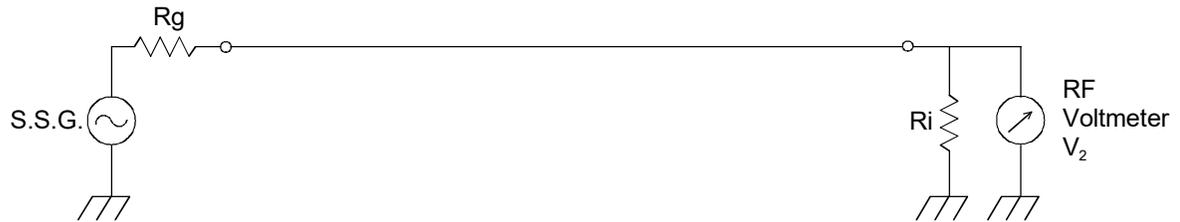
Test Circuit

(a) Measurement Circuit



2 : Input
5 : Output
Others : Ground

(b) 0dB Level



$R_g : 50 \Omega$ (Internal resistance of S.S.G.)

$R_i : 50 \Omega$ (Input impedance of network analyzer or spectrum analyzer)

$$\text{Insertion Loss} = 20 \log (V_2 / V_1) \text{ [dB]}$$

V_1 : Output voltage of Test Circuit (a)

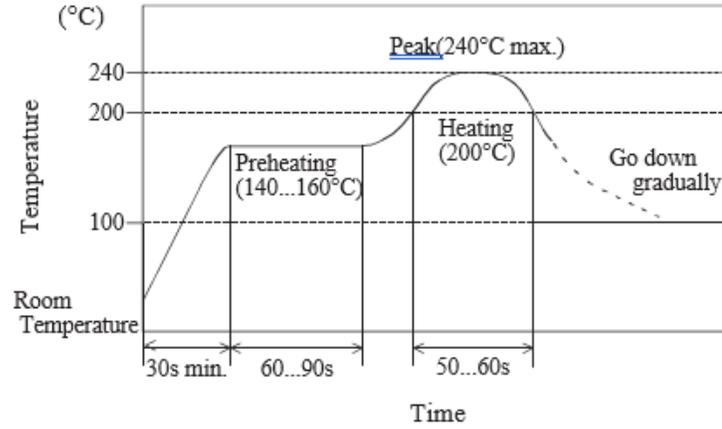
V_2 : Output voltage of Test Circuit (b)

7.5	Resistance to Soldering Heat	This component is preheated at $170\pm 10^{\circ}\text{C}$ for 90 seconds, immersed whole electrode in soldering bath at $255\pm 5^{\circ}\text{C}$ for 3 ± 1 seconds, then measured after being placed in standard atmospheric conditions for 2 hours.	The electrical performance should meet chapter 6.
7.6	Temperature Characteristics	The electrical performance is measured over $-40\sim +85^{\circ}\text{C}$ temperature range.	
7.7	Humidity	The electrical performance is measured after being placed in a chamber with 90...95% R.H. DC 3V bias at 60°C for 500 hours and then being placed in standard atmospheric conditions for 2 hours.	
7.8	Life Test (High Temperature)	The electrical performance is measured after being placed in a chamber with 85°C for 500 hours and then being placed in standard atmospheric conditions for 1 hour.	
7.9	Life Test (Low Temperature)	The electrical performance is measured after being placed in a chamber with -40°C for 500 hours and then being placed in standard atmospheric conditions for 1 hour.	
7.10	Thermal Shock	After temperature cycling of -55°C for 30 minutes to $+85^{\circ}\text{C}$ for 30 minutes performed 100 times, this component shall be returned to room temperature. And the electrical performance is measured after being placed in standard atmospheric conditions for 2 hours.	
7.11	Resistance to Reflow Soldering	The electrical performance is measured after being soldered by reflow 2 times with the following reflow profile A or B (see page 6) and then being placed in standard atmospheric conditions for 24 hours.	

Reflow Profile

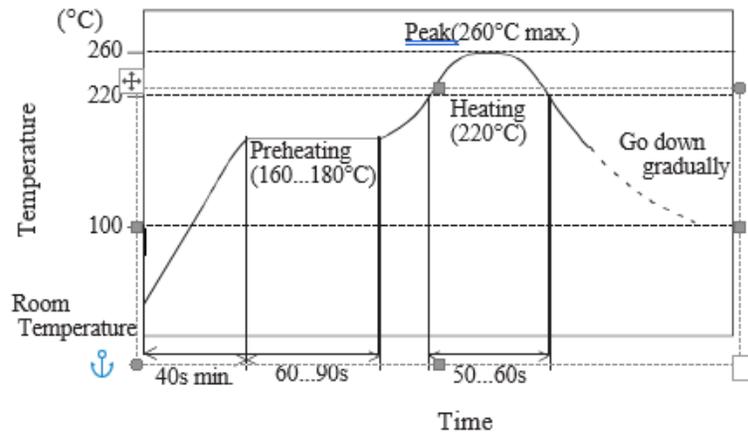
- Profile A

1. Preheating shall be fixed at 140~160°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds minimum.
3. Heating shall be fixed at 200°C for 50~60 seconds and at 230+/-10°C peak.

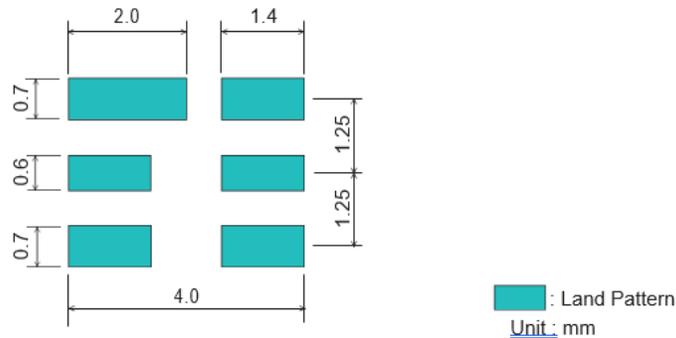


- Profile B

1. Preheating shall be fixed at 160~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 170°C shall be 40 seconds minimum.
3. Heating shall be fixed at 220°C for 50~60 seconds and at 255+/-5°C peak.



Recommended Land Pattern as follows:



8. TAPING METHOD OF PLASTIC PACKAGE

8.1 Packing

The components are packed to be prevented from being damaged. Part number, quantity and inspection number are indicated on each minimum packing unit.

8.2 Dimensions of Plastic Tape See Figure 2.

8.3 Taping Method

- (1) The Tape shall be wound clockwise. (The feeding holes shall be to the right side as the tape is pulled toward user.)
- (2) Cover tape shall not cover the feeding holes of cavity tape or overlap the edge of cavity tape.
- (3) Trailer tape shall be 160~190 mm and leader cavity shall be 80~120 mm. (Refer to Figure 1.)
- (4) The tip of the cover tape shall be adhered to the side of reel with adhesive tape (50~120mm: reference value).
- (5) The cover tape peel strength force shall be 0.2~0.6N (reference value) which measured at 170 degrees with respect to the carrier tape.
- (6) The orientation is ruled as Figure. 2 shows.
- (7) All the filters shall be packed continuously into the tape without vacant cavities except the leader cavity trailer tape area.
- (8) A reel shall contain 2000 pcs of filter.
(Please place the order with 2000 pcs times integer number. In case of small quantity shipment, bulk packing may be applied.)
- (9) Cover tape and cavity tape are made of the anti-static material.
- (10) Part number, customer part number, quantity and inspection lot number shall be marked on each reel. (The reel side containing the label will visible when the reel is oriented in a direction that dispenses the tape from the top of the reel and in a clockwise direction.)
- (11) The product which has ROHS-Y<*> mark on the packaging label is compliance with RoHS directives. The alphabet in blank <*> will be changed A to B, B to C, and so on with every revision of the RoHS directives. Please refer to the document, "The Marking for the directives on the restriction of the hazardous substances' use," to check the drectives corresponding to alphabets in <*>.

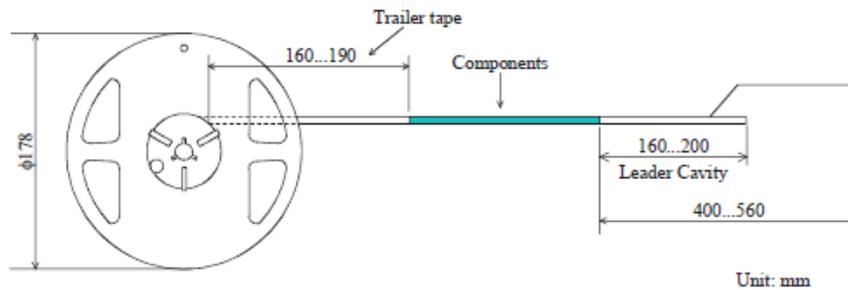
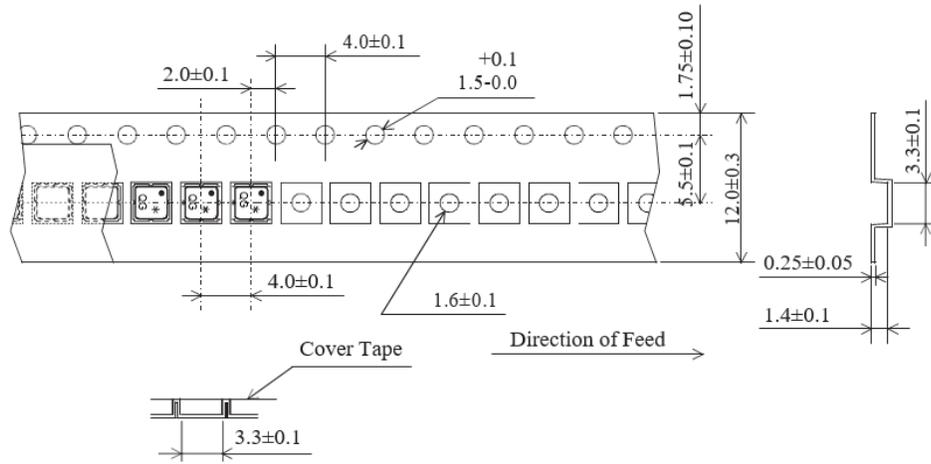


Figure. 1

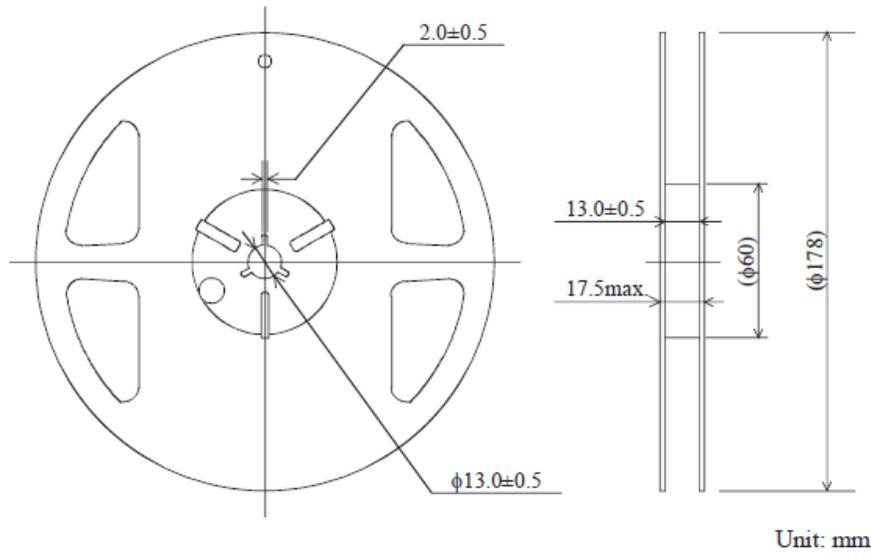
Dimensions of Carrier Tape



Unit: mm

- The marked part number faces the cover tape side.

Dimensions of Reel Tape and Reel Standard per ANSI/EIA-481



Unit: mm

Figure. 3

9. NOTICE

9.1 Usage Conditions

- I) Use this component within operating temperature range. It might not meet the specification of electrical performance out of operating temperature range. Usage on the condition of under -40°C or over $+85^{\circ}\text{C}$ might cause degradation or destruction of the component. Even a short time usage on such conditions might cause degradation of reliability.
- II) This product is designed for use of electrical equipment in the standard environment (temperature, humidity, atmospheric pressure etc.) Do not use in the following environments, since it causes degradation of characteristics and reliability.
- Ambient air containing corrosive gas (Cl_2 , H_2S , NH_3 , SO_x , NO_x , etc.)
 - Ambient air containing combustible gas and substance with high volatility
 - In dusty place
 - In the places where the water splashes or precipitates
 - Under direct sunlight
 - In the places under the strong influence of static electricity or electric field
- Contact us before using the component in such conditions.
- III) This component can not use in liquid (water, oil, chemical solution, organic solvents, etc.)
- IV) Apply electrical power lower than specified in the specification. When the component is used with higher rating power than specified in the specification, it might cause degradation or destruction of the component. Even if a short time, it might cause degradation of reliability under such a condition.
- V) Do not let the component contact with other components, since its coating is not insulated.
- VI) Rapid temperature change of this component makes electric charge. Include discharge circuit between port and ground, since it might cause degradation or destruction of this component and other components around this component.

9.2 Storage Conditions

I) Keep the component in the package or sealed container on the following conditions.

[Temperature: $-10...+40^{\circ}\text{C}$, Humidity: 30 85% R.H.]

Examine solderability before using this component, after longer than 6 months storage since it might cause degradation of solderability. Notice that long-term storage might cause discoloration.

II) To keep solderability of outer-electrode, do not store in the following environments.

- Ambient air containing corrosive gas (Cl_2 , H_2S , NH_3 , SO_x , NO_x , etc.)
- Ambient air containing combustible gas and substance with high volatility
- In dusty place
- In the places where the water splashes or precipitates
- Under direct sunlight
- In the places under the strong influence of static electricity or electric field

Contact us before using the component in such conditions.

III) Do not open the package until usage.

9.3 Soldering Conditions

I) Solder on the following condition. Contact us before soldering this component on conditions other than following since it might cause destruction.

① soldering with soldering iron

- | | | |
|---|---|---|
| •preheating condition | — | $150^{\circ}\text{C} \pm 20^{\circ}\text{C}$, 60 seconds min. |
| •temperature at the tip of the soldering iron | — | $260^{\circ}\text{C} \pm 10^{\circ}\text{C}$, or $350^{\circ}\text{C} \pm 5^{\circ}\text{C}$ |
| •Duration | — | 3seconds max. |
| •diameter at the tip of the soldering iron | — | ϕ 3mm max. |
| •power of soldering iron | — | 30Wmax. |

Avoid the contact with iron other than back or side terminals part.

②reflow soldering

- Solder on the reflow soldering condition specified in this specification

II) Use land pattern recommended in this specification, since excess solder might cause destruction of chip by mechanical stress to supply too much solder.

III) Use rosin flux. Do not use strong acid flux [ex. Flux with more than 0.2wt% Halogen compound content (converted to chlorine content.)]

IV) Use JIS-Z-3282 H63A, H60A, H50A solder or Lead free solder (Sn-3.0Ag-0.5Cu). Contact us before using other solders than above.

V) Solder with reflow soldering. Soldering with soldering iron shall be soldered on the condition specified in this specification. Since the lack of preheating gives this component rapid temperature change, it might cause degradation and destruction. Contact us before using the component on other conditions than specified in this specification.

VI) Notice that the duration of soldering with soldering iron must be considered to be accumulated time, when soldering is repeated.

VII) Use this component after examining that the outer electrodes are smoothly covered with solder thicker than 0.1mm.

9.4 Cleaning Conditions

I) Isopropyl alcohol and ethyl alcohol can be used for cleaning. Contact us before using other cleaning solvents than above. Do not use flon, trichloroethane etc in the point of view to protect for global environment.

II) Clean this component after ensuring that the temperature of the component is room temperature, since rapid temperature change by cleaning after reflow soldering might cause degradation or destruction.

III) As ultrasonic vibration might be a cause of degradation or destruction, contact the manufacturer before using ultrasonic cleaning.

IV) Dry this component immediately after cleaning.

V) In the case that cleaning process is included in the manufacturing process, examine the influence to the performance of the component with mounting on PCB before use.

9.5 Handling Conditions

- I) Notice that it might cause destruction to apply larger shock than specified in the specification while handling.

- II) Notice that it might cause reliability degradation to apply excessive shock or vibration during transportation.

- III) Do not apply any shock or pressure to this component during transportation when the component is on PCB.

- IV) Do not apply static electricity or excessive voltage while assembling and measuring, since it might cause degradation or destruction to apply static electricity to this component.

- V) Do not handle this component with bare hand.

9.6 Mounting Conditions

- I) Mount this component not to apply a stress caused by warp or bend of PCB.

- II) Abraded positioning claw, pick-up nozzle, etc of component placement machine might apply excessive shock on the component on PCB and cause destruction. Keep the maintenance which is instructed on each machine regularly to prevent the component from these kinds of troubles.

- III) Mount all terminals, or terminal strength might be degraded.

- IV) Mount the component on PCB with no space between component and PCB.

9.7 Application

I) Please contact us before using our products for the applications listed below which require especially for the prevention of defects which might directly cause damage to the third party's life, body or property.

- ① Aircraft equipment
- ② Aerospace equipment
- ③ Undersea equipment
- ④ Nuclear control equipment
- ⑤ Medical equipment
- ⑥ Transportation equipment (vehicles, trains, ships, etc.)
- ⑦ Traffic signal equipment
- ⑧ Disaster prevention / crime prevention equipment
- ⑨ Data - processing equipment
- ⑩ Application of similar complexity and / or reliability requirements to the applications listed in the above.

NOTE

I) Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.

II) You are requested not to use our product deviating from such agreement.

III) We consider it not appropriate to include other terms and conditions for transaction warranty in product specifications, drawings or other technical documents. Therefore, even if your original part of this approval sheet for product specification includes such terms and conditions as warranty clause, product liability clause, or intellectual property infringement liability clause, we are not able to accept such terms and conditions in this approval sheet for product specification unless they are based on the governmental regulation or what we have agreed otherwise in a separate contract. We would like to suggest that you propose to discuss them under negotiation of contract.

Others:

This product conforms to the provisions on the control of "Environmental Hazardous Substances" in Alps Electric Co., Ltd., Green Procurement Standard.